



TECHNOLOGY DAYS 2015 PROGRAM

22nd April

8:00 am	Entrance
8:45	Scheugenpflug product portfolio presentation by the sales team
9:30	Silicones for power electronics Dr. Markus Jandke, Wacker Chemie AG
10:30	A new generation of silicone gap filler and adhesives for more efficient processing Sandrine Teixeira de Carvalho, Senior Automotive Electronics Application Engineer, Dow Corning Europe SA
11:30	Application of atmospheric plasma technology in the electronic industry Dipl.-Ing. (FH) Werner Krammel, Plasmatrete GmbH
12:15	New Polyurethane- and Epoxy Resins for High Temperature Applications Dr. Peter Gräter, WEVO-CHEMIE GmbH
1:30 pm	Technical Service – five most common errors in maintenance, supportive tools, hotline support Scheugenpflug AG
2:30	Total encapsulation of electronic drives Ulf Koschmieder, Sales Engineer, ELANTAS Beck GmbH
3:30	Epoxy- and Polyurethane-based Encapsulants for automotive applications Dr. Werner Hollstein, Technical Support Electronic & Electrical Engineering, Huntsman Advanced Materials GmbH
4:30	Optimized Epoxy Casting Resins for Highly Reliable Automotive Sensors with Increased Environmental Requirements Dipl.-Ing. (FH) Martin Böttcher, DELO Industrial Adhesives GmbH & Co. KGaA
5:30	Trends on thermal conductive Liquids. Product requirements, Applications, Process Holger Schuh, BQ EU Liquid and Dispensing Expert, The Bergquist Company GmbH

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